

Features

- Split Gate Trench Mosfet Technology
- · Excellent Package for Heat Dissipation
- · High Density Cell Design for Low RDS(on)
- Moisture Sensitivity Level 3
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

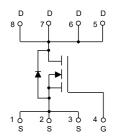
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 50°C/W Junction to Ambient^(Note 2)
- Thermal Resistance: 1°C/W Junction to Case

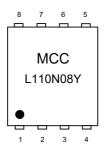
Parameter		Symbol	Rating	Unit	
Drain-Source Voltage		V _{DS}	80	V	
Gate-Source Volltage		V _{GS}	±20	V	
Continuous Drain Current	T _C =25°C		110	_	
	T _C =100°C	- I _D	69	Α	
Pulsed Drain Current (Note 3)		I _{DM}	440	Α	
Total Power Dissipation (Note 4)		P _D	125	W	
Avalanche Energy (Note 5)		E _{AS}	846	mJ	

Note:

- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. The value of RθJA is measured with the device mounted on 1 in ² FR-4 board with 2oz. copper, in a still air environment with TJ=25°C.
- 3. Repetitive rating; pulse width limited by max. junction temperature.
- 4. P_D is based on max. junction temperature, using junction-case thermal resistance.
- 5. V_{DD} =50V, R_{G} =25 Ω , V_{G} =10V,L=3mH.

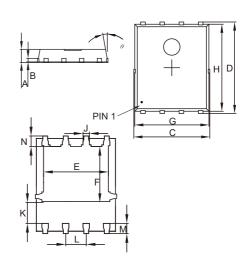
Internal Structure and Marking Code





N-CHANNEL MOSFET

DFN5060



	DIMENSIONS					
DIM	INCHES		MM		NOTE	
Dilvi	MIN	MAX	MIN	MAX	NOIL	
Α	0.031	0.047	0.80	1.20		
В	0.010		0.254		TYP.	
С	0.193	0.222	4.90	5.64		
D	0.232	0.250	5.90	6.35		
Е	0.148	0.167	3.75	4.25		
F	0.126	0.154	3.20	3.92		
G	0.189	0.213	4.80	5.40		
Н	0.222	0.239	5.65	6.06		
K	0.045	0.059	1.15	1.50		
J	0.012	0.020	0.30	0.50		
L	0.046	0.054	1.17	1.37		
М	0.012	0.028	0.30	0.71		
N	0.016	0.028	0.40	0.71		

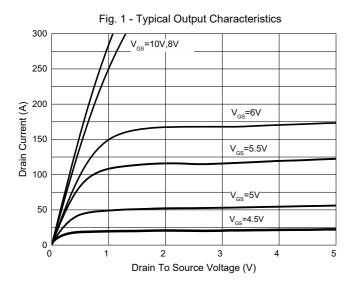


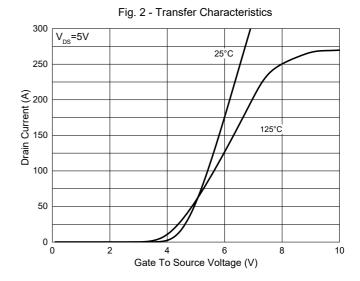
Electrical Characteristics @ 25°C (Unless Otherwise Specified)

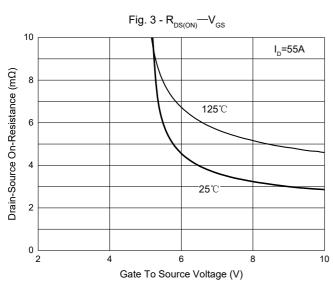
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static Characteristics				1		1	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	80			V	
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =80V, V _{GS} =0V			1	μA	
		V _{DS} =80V, V _{GS} =0V,Tj=150 °C			100		
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3	4	V	
Drain-Source On-Resistance	Б	V _{GS} =10V, I _D =55A	2.9 3.9		3.9	m0	
	R _{DS(on)}	V _{GS} =6V, I _D =20A		4.5	6	mΩ	
Gate resistance	R _G	f=1MHz, Open drain		2		Ω	
Diode Characteristics				•			
Continuous Body Diode Current	I _S				110	Α	
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =55A		0.9	1.2	V	
Reverse Recovery Time	t _{rr}	I _S =55A,di/dt=100A/μs		52		ns	
Reverse Recovery Charge	Q _{rr}	18-33A,ui/ut-100A/µs		57		nC	
Dynamic Characteristics							
Input Capacitance	C _{iss}			5947			
Output Capacitance	C _{oss}	V _{DS} =40V,V _{GS} =0V,f=1MHz		870		pF	
Reverse Transfer Capacitance	C _{rss}			28			
Total Gate Charge	Q_g			79			
Gate-Source Charge	Q _{gs}	V _{DS} =40V,V _{GS} =10V,I _D =55A		33		nC	
Gate-Drain Charge	Q _{gd}			13			
Turn-On Delay Time	t _{d(on)}			25			
Turn-On Rise Time	t _r	V _{GS} =10V, V _{DD} =40V,		59		- ns	
Turn-Off Delay Time	t _{d(off)}	I_D =55A, R_{GEN} =3 Ω		50			
Turn-Off Fall Time	t _f			21			

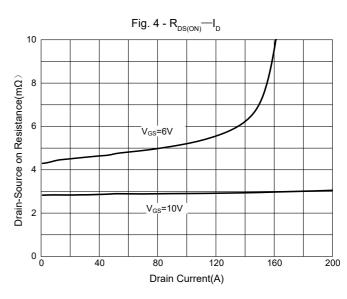


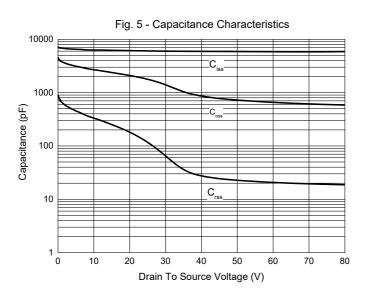
Curve Characteristics

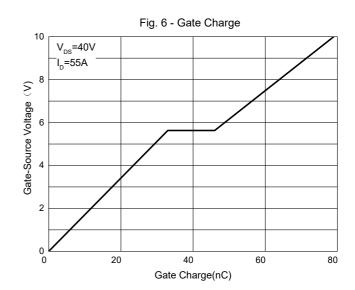






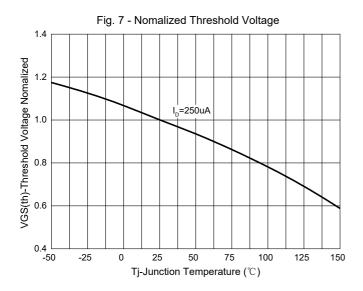


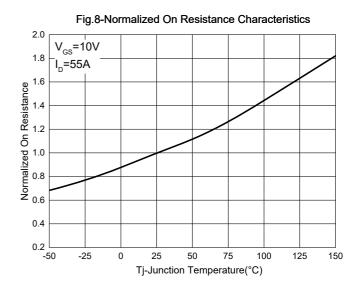


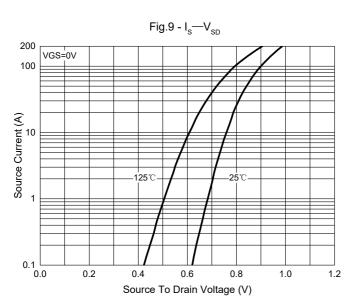


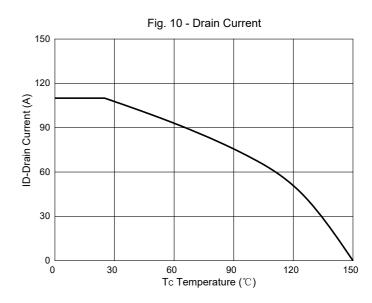


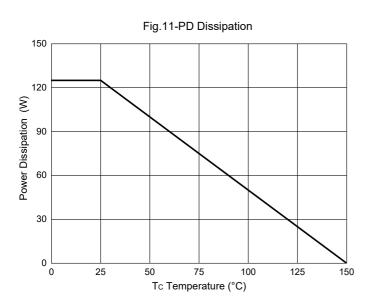
Curve Characteristics





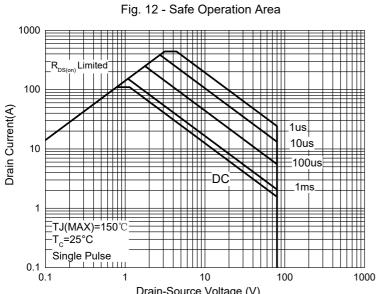






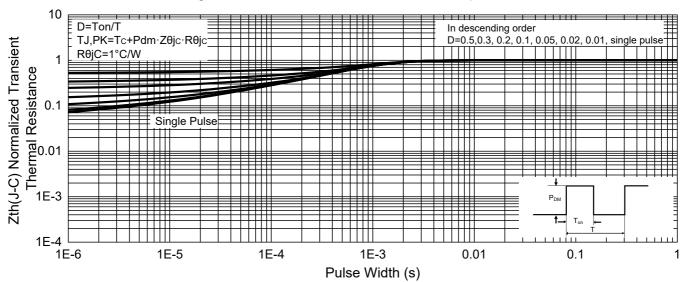


Curve Characteristics



Drain-Source Voltage (V)

Fig. 13 -Normalized Transient Thermal Impedance





Ordering Information

Device	Packing	
Part Number-TP	Tape&Reel: 5Kpcs/Reel	

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